

The RF Line

NPN Silicon

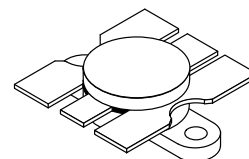
RF Power Transistor

... designed for 12.5 Volt UHF large-signal amplifier applications in industrial and commercial FM equipment operating to 512 MHz.

- Specified 12.5 Volt, 470 MHz Characteristics —
Output Power = 25 Watts
Minimum Gain = 6.2 dB
Efficiency = 60%
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- Built-In Matching Network for Broadband Operation
- Tested for Load Mismatch Stress at all Phase Angles with 20:1 VSWR @ 16-Volt High Line and 50% Overdrive
- Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.

MRF644

**25 W, 470 MHz
CONTROLLED Q
RF POWER
TRANSISTOR
NPN SILICON**



CASE 316-01, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	16	Vdc
Collector-Base Voltage	V_{CBO}	36	Vdc
Emitter-Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous	I_C	4.0	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	103 0.59	Watts W/ $^\circ\text{C}$
Storage Temperature Range	T_{stg}	-65 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.7	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage ($I_C = 20 \text{ mAdc}$, $I_B = 0$)	$V_{(BR)CEO}$	16	—	—	Vdc
Collector-Emitter Breakdown Voltage ($I_C = 20 \text{ mAdc}$, $V_{BE} = 0$)	$V_{(BR)CES}$	36	—	—	Vdc
Emitter-Base Breakdown Voltage ($I_E = 5.0 \text{ mAdc}$, $I_C = 0$)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current ($V_{CE} = 15 \text{ Vdc}$, $V_{BE} = 0$, $T_C = 25^\circ\text{C}$)	I_{CES}	—	—	5.0	mAdc

(continued)

ELECTRICAL CHARACTERISTICS — continued ($T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS					
DC Current Gain ($I_C = 4.0 \text{ Adc}$, $V_{CE} = 5.0 \text{ Vdc}$)	h_{FE}	40	70	100	—

DYNAMIC CHARACTERISTICS

Output Capacitance ($V_{CB} = 12.5 \text{ Vdc}$, $I_E = 0$, $f = 1.0 \text{ MHz}$)	C_{ob}	—	60	85	pF
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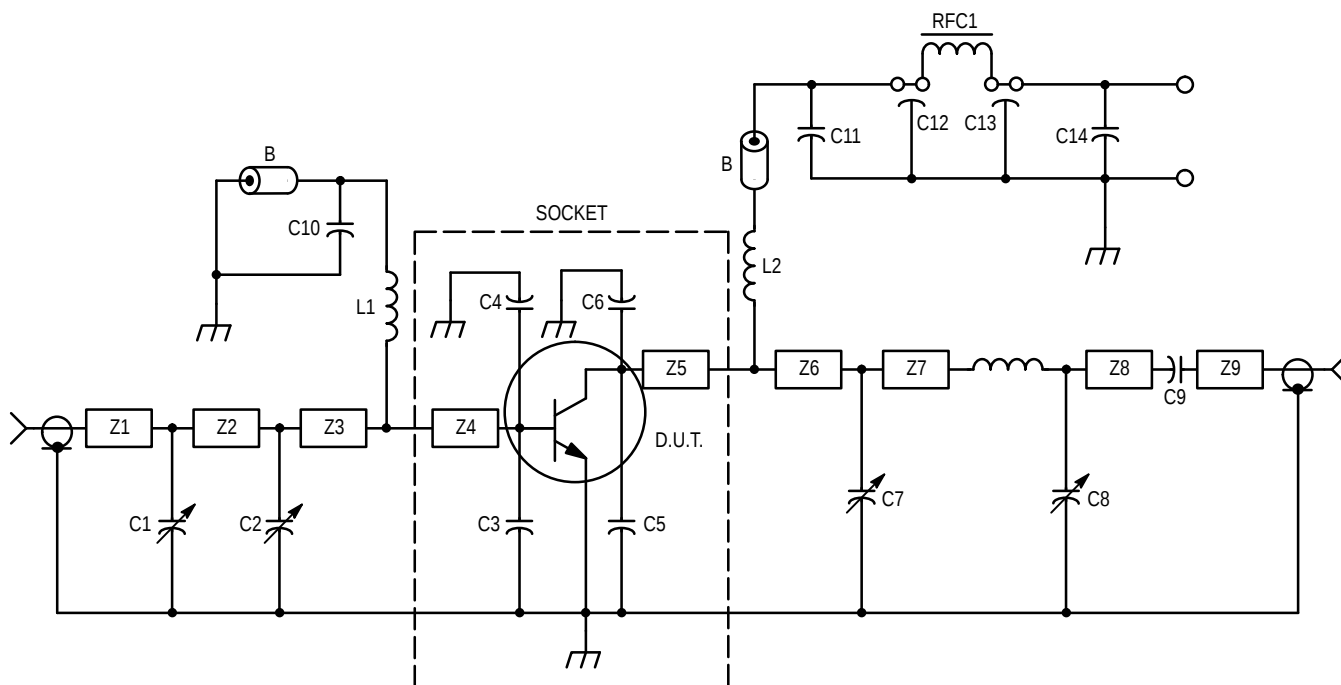
FUNCTIONAL TESTS

Common-Emitter Amplifier Power Gain ($V_{CC} = 12.5 \text{ Vdc}$, $P_{out} = 25 \text{ W}$, $I_C (\text{MAX}) = 3.6 \text{ Adc}$, $f = 470 \text{ MHz}$)	G_{pe}	6.2	7.0	—	dB
Input Power ($V_{CC} = 12.5 \text{ Vdc}$, $P_{out} = 25 \text{ W}$, $f = 470 \text{ MHz}$)	P_{in}	—	5.0	6.0	Watts
Collector Efficiency ($V_{CC} = 12.5 \text{ Vdc}$, $P_{out} = 25 \text{ W}$, $I_C (\text{MAX}) = 3.6 \text{ Adc}$, $f = 470 \text{ MHz}$)	η	55	60	—	%
Output Mismatch Stress ($V_{CC} = 16 \text{ Vdc}$, $P_{in} = \text{Note 1}$, $f = 470 \text{ MHz}$, $V_{SWR} = 20:1$, All Phase Angles)	ψ^*	No Degradation in Output Power			
Series Equivalent Input Impedance ($V_{CC} = 12.5 \text{ Vdc}$, $P_{out} = 25 \text{ W}$, $f = 470 \text{ MHz}$)	Z_{in}	—	$1.2 + j3.3$	—	Ohms
Series Equivalent Output Impedance ($V_{CC} = 12.5 \text{ Vdc}$, $P_{out} = 25 \text{ W}$, $f = 470 \text{ MHz}$)	Z_{OL}	—	$1.9 + j2.1$	—	Ohms

NOTE:

1. $P_{in} = 150\%$ of Drive Requirement for 25 W Output at 12.5 Vdc.

* ψ = Mismatch stress factor — the electrical criterion established to verify the device resistance to load mismatch failure. The mismatch stress test is accomplished in the standard test fixture (Figure 1) terminated in a 20:1 minimum load mismatch at all phase angles.



C1, C2, C7, C8 — 1.0–20 pF Johanson Variable
 C3 — 27 pF 100 mil ATC
 C4 — 30 pF 100 mil ATC
 C5, C6 — 33 pF 100 mil ATC
 C9 — 250 pF 100 mil ATC
 C10 — 100 pF UNELCO
 C11, C14 — 1.0 μF 35 V TANTALUM

C12, C13 — 680 pF Feedthrough
 L1 — 5" #22 AWG 0.100" ID
 L2 — 5" #20 AWG 0.187" ID
 RFC1 — Ferroxcube VK200–20–4B
 B — Ferroxcube Bead 56–590–65–3B
 Z1 — 0.25" x 0.20" Microstrip
 Z2 — 1.63" x 0.20" Microstrip

Z3 — 0.20" x 0.20" Microstrip
 Z4, Z5 — 1/2" #18 AWG bent in a
 "V" shape 1/8" Wide
 Z6 — 0.20" x 0.20" Microstrip
 Z7 — 0.70" x 0.20" Microstrip
 Z8 — 0.33" x 0.20" Microstrip
 Z9 — 0.50" x 0.20" Microstrip
 Board — 62.5 mil Glass Teflon, $\epsilon_r = 2.55$

Figure 1. Test Circuit Schematic

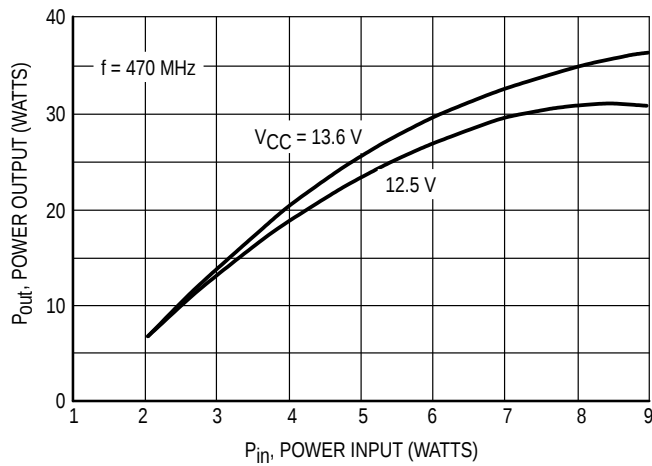


Figure 2. Power Output versus Power Input

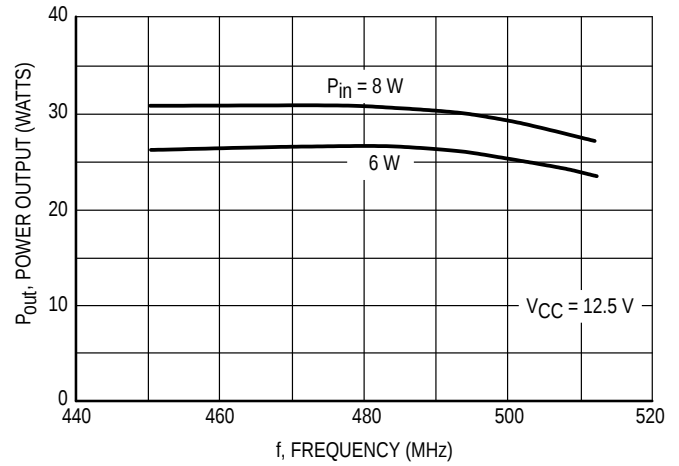


Figure 3. Power Output versus Frequency

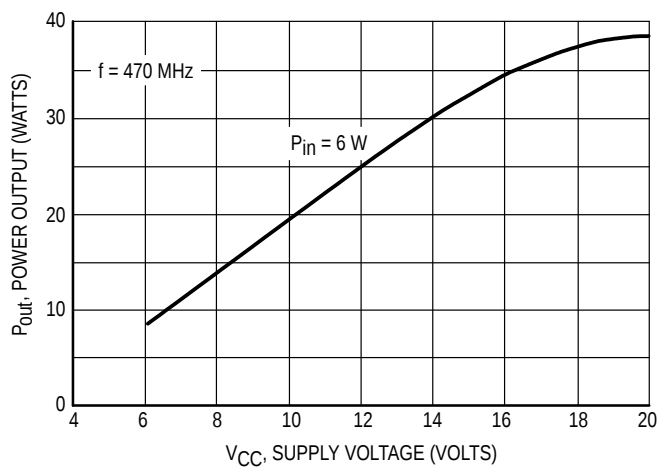


Figure 4. Power Output versus Supply Voltage

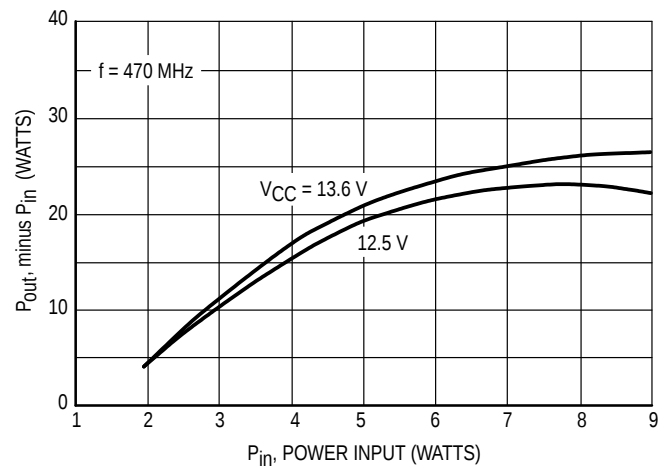


Figure 5. Power Saturation Profile

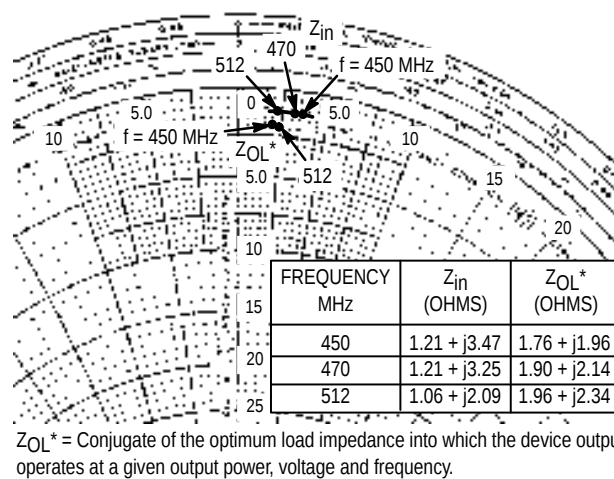
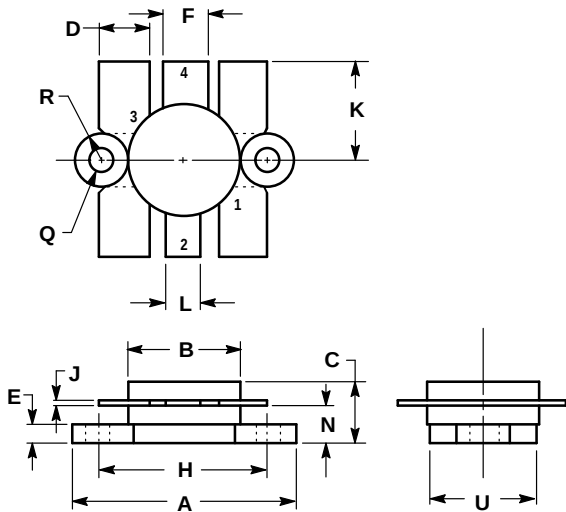


Figure 6. Series Equivalent Input-Output Impedance

PACKAGE DIMENSIONS



NOTES:
1. FLANGE IS ISOLATED IN ALL STYLES.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	24.38	25.14	0.960	0.990
B	12.45	12.95	0.490	0.510
C	5.97	7.62	0.235	0.300
D	5.33	5.58	0.210	0.220
E	2.16	3.04	0.085	0.120
F	5.08	5.33	0.200	0.210
H	18.29	18.54	0.720	0.730
J	0.10	0.15	0.004	0.006
K	10.29	11.17	0.405	0.440
L	3.81	4.06	0.150	0.160
N	3.81	4.31	0.150	0.170
Q	2.92	3.30	0.115	0.130
R	3.05	3.30	0.120	0.130
U	11.94	12.57	0.470	0.495

STYLE 1:
PIN 1. EMITTER
2. COLLECTOR
3. EMITTER
4. BASE

CASE 316-01
ISSUE D

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